

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10527604			
<b>Filing Date:</b>	15-Mar-2005			
<b>Title of Invention:</b>	Thermoplastic resin composition and moldings thereof			
<b>First Named Inventor/Applicant Name:</b>	Kazuhiko Maeda			
<b>Filer:</b>	Richard L. Cruz/Victorine Meise			
<b>Attorney Docket Number:</b>	SPL-05-1048			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 2 months with \$120 paid	1252	1	340	340

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				340